

N-Channel Enhancement-Mode MOS Transistors

Product Summary

| Part Number | $V_{(BR)DSS}$ Min (V) | $r_{DS(on)}$ Max (Ω) | $V_{GS(th)}$ (V) | I_D Min (mA) |
|-------------|-----------------------|-------------------------------|------------------|----------------|
| TN2460L | 240 | 60 @ $V_{GS} = 10$ V | 0.5 to 1.8 | 75 |
| TN2460T | | 60 @ $V_{GS} = 10$ V | 0.5 to 1.8 | 51 |

Features

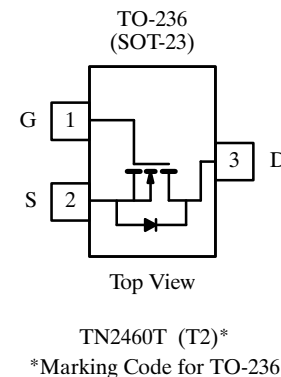
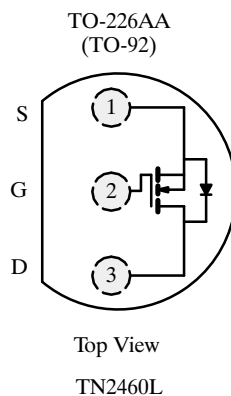
- Low On-Resistance: 40 Ω
- Secondary Breakdown Free: 260 V
- Low Power/Voltage Driven
- Low Input and Output Leakage
- Excellent Thermal Stability

Benefits

- Low Offset Voltage
- Full-Voltage Operation
- Easily Driven Without Buffer
- Low Error Voltage
- No High-Temperature "Run-Away"

Applications

- High-Voltage Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Transistors, etc.
- Telephone Mute Switches, Ringer Circuits
- Power Supply, Converters
- Motor Control



Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

| Parameter | Symbol | TN2460L | TN2460T | Unit |
|--|----------------|---------------------------|----------|--------------------|
| Drain-Source Voltage | V_{DS} | 240 | 240 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | ± 20 | |
| Continuous Drain Current ($T_J = 150^\circ\text{C}$) | I_D | $T_A = 25^\circ\text{C}$ | 75 | mA |
| | | $T_A = 100^\circ\text{C}$ | 48 | |
| Pulsed Drain Current | I_{DM} | 800 | 400 | |
| Power Dissipation | P_D | $T_A = 25^\circ\text{C}$ | 0.8 | W |
| | | $T_A = 100^\circ\text{C}$ | 0.32 | |
| Maximum Junction-to-Ambient | R_{thJA} | 156 | 350 | $^\circ\text{C/W}$ |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | -55 to 150 | | $^\circ\text{C}$ |

Notes

- a. Pulse width limited by maximum junction temperature.

TN2460L/TN2460T

Specifications^a

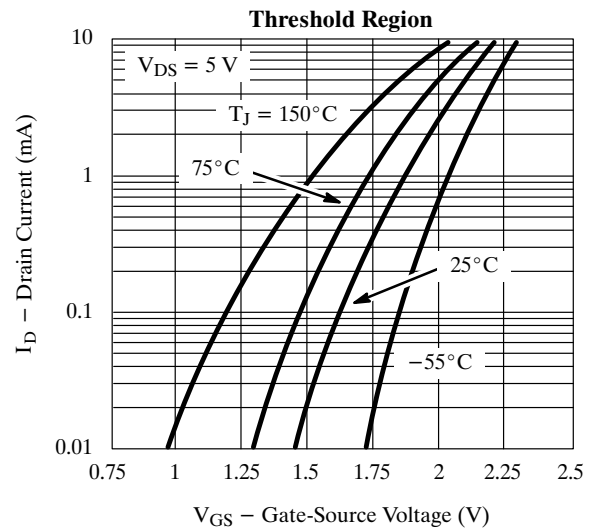
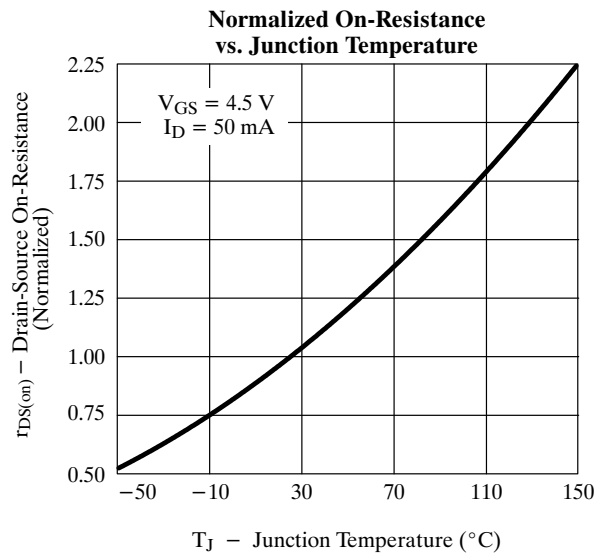
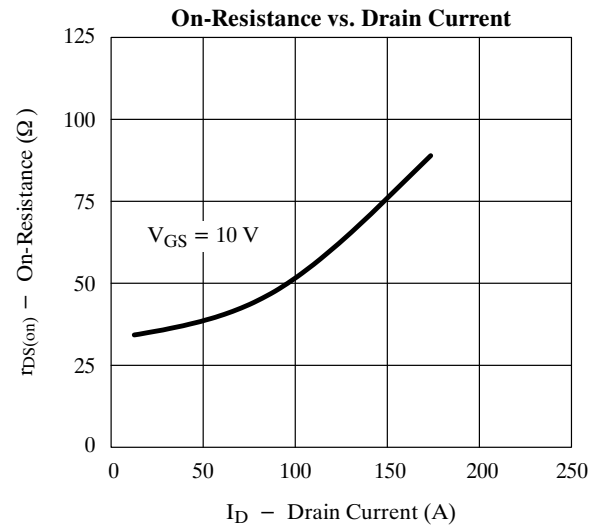
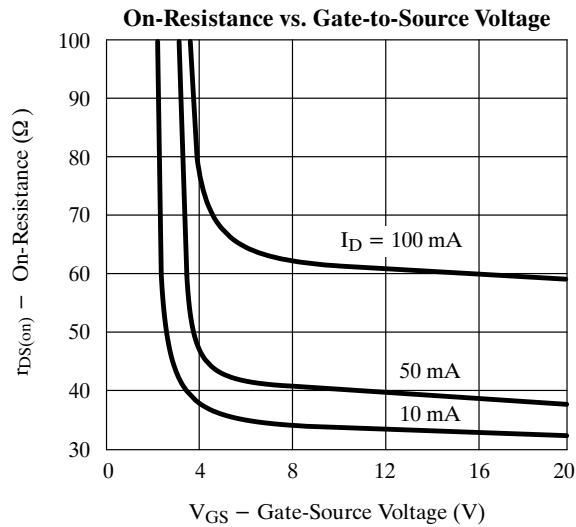
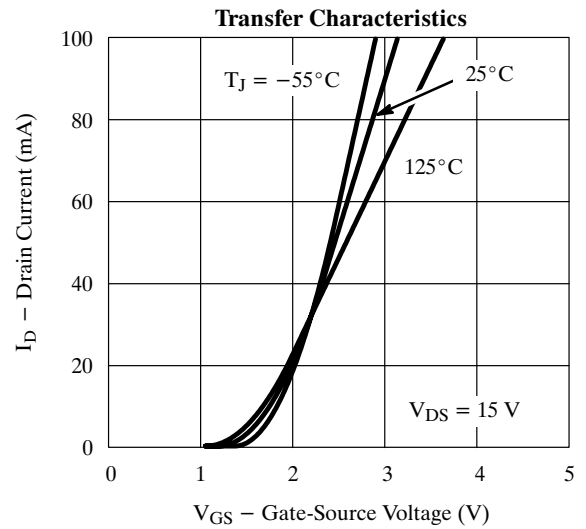
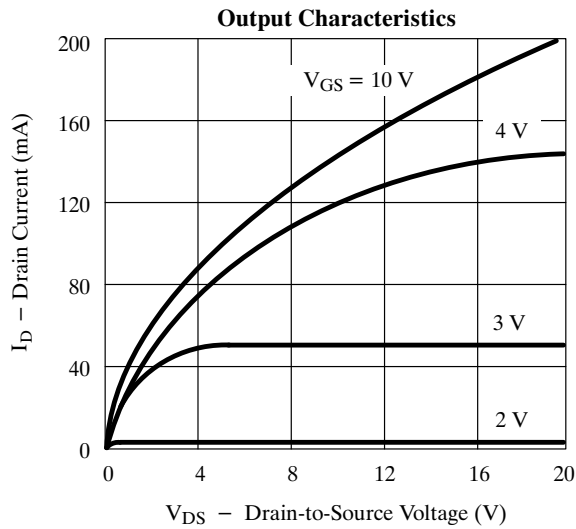
| Parameter | Symbol | Test Conditions | Limits | | | Unit |
|---|---------------|--|--------|------------------|----------|---------------|
| | | | Min | Typ ^b | Max | |
| Static | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0\text{ V}, I_D = 10\ \mu\text{A}$ | 240 | 260 | | V |
| Gate-Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$ | 0.5 | 1.65 | 1.8 | |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$ $T_J = 125^\circ\text{C}$ | | | ± 10 | nA |
| | | | | ± 5 | | |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 120\text{ V}, V_{GS} = 0\text{ V}$ $T_J = 125^\circ\text{C}$ | | | 0.1 | μA |
| | | | | | 5 | |
| On-State Drain Current ^c | $I_{D(on)}$ | $V_{DS} = 10\text{ V}, V_{GS} = 10\text{ V}$ $V_{DS} = 10\text{ V}, V_{GS} = 4.5\text{ V}$ | 75 | 140 | | mA |
| | | | 20 | 130 | | |
| Drain-Source On-Resistance ^c | $r_{DS(on)}$ | $V_{GS} = 10\text{ V}, I_D = 0.05\text{ A}$ $V_{GS} = 4.5\text{ V}, I_D = 0.02\text{ A}$ $T_J = 125^\circ\text{C}$ | | 38 | 60 | Ω |
| | | | | 40 | 60 | |
| | | | | 75 | 120 | |
| Forward Transconductance ^c | g_{fs} | $V_{DS} = 10\text{ V}, I_D = 0.05\text{ A}$ | 30 | 70 | | mS |
| Dynamic | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$ | | 14 | 30 | pF |
| Output Capacitance | C_{oss} | | | 4 | 15 | |
| Reverse Transfer Capacitance | C_{rss} | | | 1 | 10 | |
| Switching^d | | | | | | |
| Turn-On Time | t_{ON} | $V_{DD} = 25\text{ V}, R_L = 500\ \Omega$ $I_D \cong 0.05\text{ A}, V_{GEN} = 10\text{ V}$ $R_G = 25\ \Omega$ | | 8 | 20 | ns |
| Turn-Off Time | t_{OFF} | | | 20 | 35 | |

Notes

- $T_A = 25^\circ\text{C}$ unless otherwise noted.
- For DESIGN AID ONLY, not subject to production testing.
- Pulse test: $PW \leq 80\ \mu\text{s}$ duty cycle $\leq 1\%$.
- Switching time is essentially independent of operating temperature.

VNDN24

Typical Characteristics (25°C Unless Otherwise Noted)



TN2460L/TN2460T

Typical Characteristics (25°C Unless Otherwise Noted) (Cont'd)

